

05-20-2003

Docket No.: POU920030074US1

FORM PTO-1595 (Modified)
(Rev. 03-01)
OMB No. 0651-0027 (exp. 5/31/2002)
P08A/REV03



SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

.Y

Tab settings → → → ▼

102452631

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yuen H. Chan, Rajiv Joshi, Antonio R. Pelella,
John R. Rawlins and Jatinder K. Wadhwa

5.12.03

2. Name and address of receiving party(ies):

Name: International Business Machines Corporation

Address: New Orchard Road

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

City: Armonk

State/Prov.: NY

Country: USA

ZIP: 10504

Execution Date: 5-9-2003

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

10436229

If this document is being filed together with a new application, the execution date of the application is: 5-9-2003

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Philmore H. Colburn II

Registration No. 35,101

Address: Cantor Colburn LLP

55 Griffin Road South

City: Bloomfield

State/Prov.: CT

Country: USA

ZIP: 06002

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

8. Deposit account number:

09-0463

(Attach duplicate copy of this page if paying by deposit account)

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Troy J. LaMontagne, Reg. No. 47,239

Name of Person Signing

Signature

May 12, 2003

Date

5

Total number of pages including cover sheet, attachments, and

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

PATENT

REEL: 014069 FRAME: 0169

J1046 U.S. PTO

10/436229

05/12/03

10436229

09-0463

05/20/2003 LMUELLER 00000032 09-0463

01 REC:0021

A S S I G N M E N T

Whereas, We

- Inventor (1) Yuen H. Chan of 35 High Acres Drive City of Poughkeepsie
County of Dutchess and State of NY 12603
- Inventor (2) Rajiv Joshi of 1418 Pinebrook Court City of Yorktown Heights
County of Westchester and State of NY 10598
- Inventor (3) Antonio R. Pelella of 24 Regina Road City of Highland Falls
County of Orange and State of NY 10928
- Inventor (4) John R. Rawlins of 20 Hawk Hill Road City of New Paltz
County of Ulster and State of NY 12561
- Inventor (5) Jatinder K. Wadhwa of 34C Winthrop Court
City of Wappingers Falls
County of Dutchess and State of NY 12590

have invented certain improvements in

HIGH PERFORMANCE DUAL-STAGE SENSE AMPLIFIER CIRCUIT

and executed, respectively, a United States patent application therefore on

(1) <u>Yuen H. Chan</u>	(2) <u>John R. Rawlins</u>
(3) <u>Antonio R. Pelella</u>	(4) <u>Jatinder K. Wadhwa</u>
(5) <u>_____</u>	

Whereas, **INTERNATIONAL BUSINESS MACHINES CORPORATION**, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM,) desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, and, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents and Trademarks to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed

(1) at Poughkeepsie, NY
on May 9, 2003

Yuen H. Chan
Yuen H. Chan

(2) at _____
on _____

Rajiv Joshi

(3) at Poughkeepsie, NY
on May 9, 2003

Antonio R. Pelella
Antonio R. Pelella

(4) at Poughkeepsie, N.Y.
on May 9, 2003

John R. Rawlins
John R. Rawlins

(5) at POUGHKEEPSIE, NY
on May 9th, 2003

Jatinder K. Wadhwa
Jatinder K. Wadhwa

A S S I G N M E N T

Whereas, We

- Inventor (1) Yuen H. Chan of 35 High Acres Drive City of Poughkeepsie
County of Dutchess and State of NY 12603
- Inventor (2) Rajiv Joshi of 1418 Pinebrook Court City of Yorktown Heights
County of Westchester and State of NY 10598
- Inventor (3) Antonio R. Pelella of 24 Regina Road City of Highland Falls
County of Orange and State of NY 10928
- Inventor (4) John R. Rawlins of 20 Hawk Hill Road City of New Paltz
County of Ulster and State of NY 12561
- Inventor (5) Jatinder K. Wadhwa of 34C Winthrop Court
City of Wappingers Falls
County of Dutchess and State of NY 12590

have invented certain improvements in

HIGH PERFORMANCE DUAL-STAGE SENSE AMPLIFIER CIRCUIT

and executed, respectively, a United States patent application therefore on

- (1) _____ (2) May 9, 2003
- (3) _____ (4) _____
- (5) _____

Whereas, **INTERNATIONAL BUSINESS MACHINES CORPORATION** a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM,) desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, and, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents and Trademarks to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed

(1) at _____
on _____
Yuen H. Chan

(2) at IBM (Yorktown Heights), NY Rajiv V. Joshi
on May 9, 2003 Rajiv Joshi

(3) at _____
on _____
Antonio R. Pelella

(4) at _____
on _____
John R. Rawlins

(5) at _____
on _____
Jatinder K. Wadhwa